

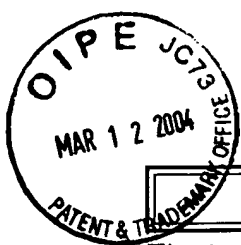
Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
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EFS ID: 57018  
Application ID: 10706468  
Title of Invention: SEMICONDUCTOR PACKAGE  
WITH CHAMFERED CORNERS  
AND METHOD OF  
MANUFACTURING THE SAME  
First Named Inventor: Sung Yang  
Domestic/Foreign Application: Domestic Application  
Filing Date: 2003-11-12  
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Submission Type: Information Disclosure  
Statement  
Filing Type:  
Confirmation number: 6744  
Attorney Docket Number: AMKOR095A




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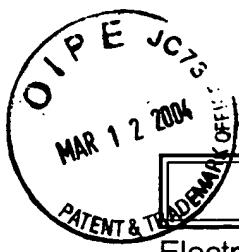
Digital Certificate Holder: cn=Mark B. Garred,ou=Registered Attorneys,ou=Patent and Trademark  
Office,ou=Department of Commerce,o=U.S. Government,c=US  
Certificate Message Digest: 35635b221c865a9b04ef52db1f2163fd002f458d

**TRANSMITTAL**

Electronic Version v1.1

Stylesheet Version v1.1.0

<b>Title of Invention</b>	<b>SEMICONDUCTOR PACKAGE WITH CHAMFERED CORNERS AND METHOD OF MANUFACTURING THE SAME</b>									
Application Number: 10/706468 										
Date: 2003-11-12										
First Named Applicant: Sung Jin Yang										
Confirmation Number: 6744										
Attorney Docket Number: AMKOR095A										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Mark B. Garred Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Mark B. Garred Registered Number: 34,823	/mbg/	Attorney		
Submitted by:	Elec. Sign.	Sign. Capacity								
Mark B. Garred Registered Number: 34,823	/mbg/	Attorney								
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Documents being submitted	Files									
us-ids	ids4-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
<b>Comments</b>										



## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of  
Invention

SEMICONDUCTOR PACKAGE WITH CHAMFERED  
CORNERS AND METHOD OF MANUFACTURING THE  
SAME

Application Number: 10/706468  
Confirmation Number: 6744  
First Named Applicant: Sung Yang  
Attorney Docket Number: AMKOR095A  
Art Unit: 2811

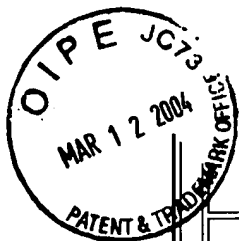


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or 5969426 or 5973388 or 5977630 or 5977615  
or 5977613 or 5976912 or 5981314 or 5986885  
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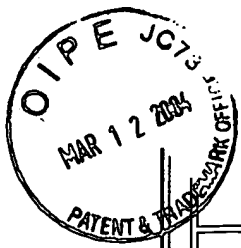
### US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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	2	5909053	1999-06-01	FUKASE ET AL.			
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	48	6181002	2001-01-30	JUSO ET AL
	49	6184573	2001-02-06	PU
	50	6184465	2001-02-06	CORISIS

Signature

Examiner Name	Date